

### **Description**

The DMN6040SSD uses advanced trench technology

to provide excellent R<sub>DS(ON)</sub>, low gate charge and

operation with gate voltages as low as 2.5V. This

device is suitable for use as a

Battery protection or in other Switching application.



SOP-8

#### **General Features**

V<sub>DS</sub> = 60V I<sub>D</sub> = 6.5 A

 $R_{DS(ON)}$  < 36m $\Omega$  @  $V_{GS}$ =10 V

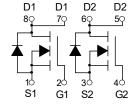
 $R_{DS(ON)}$  < 48m $\Omega$  @ V<sub>GS</sub>=4.5V

## **Application**

Battery protection

Load switch

Uninterruptible power supply



**Dual N-Channel MOSFET** 

#### **Package Marking and Ordering Information**

Product ID	Pack	Brand	Qty(PCS)
DMN6040SSD	SOP-8	HXY MOSFET	3000

### Absolute Maximum Ratings@T<sub>i</sub>=25°C(unless otherwise specified)

Symbol	Parameter	Rating	Units
V <sub>DS</sub>	Drain-Source Voltage	60	V
V <sub>GS</sub>	Gate-Source Voltage	<u>+</u> 20	V
I <sub>D</sub> @T <sub>A</sub> =25°C	Drain Current, V <sub>GS</sub> @ 4.5V <sup>3</sup>	6.5	Α
I <sub>D</sub> @T <sub>A</sub> =70°C	Drain Current, V <sub>GS</sub> @ 4.5V <sup>3</sup>	5	А
Ірм	Pulsed Drain Current <sup>1</sup>	30	А
P <sub>D</sub> @T <sub>A</sub> =25°C	Total Power Dissipation	2.1	W
Тѕтс	Storage Temperature Range	-55 to 150	°C
TJ	Operating Junction Temperature Range	-55 to 150	°C
Rthj-a	Maximum Thermal Resistance, Junction- ambient <sup>3</sup>	60	°C/W



## Electrical Characteristics (T<sub>A</sub>=25 ℃ unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V I <sub>D</sub> =250μA	V <sub>GS</sub> =0V I <sub>D</sub> =250μA 60 6		-	V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =60V,V <sub>GS</sub> =0V	-	-	1	μA
Gate-Body Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> =±20V,V <sub>DS</sub> =0V	-	-	±100	nA
On Characteristics (Note 3)						
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS}=V_{GS}$ , $I_{D}=250\mu A$	1.0	1.4	2.0	V
D : 0	R <sub>DS(ON)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =6A		32	36	mΩ
Drain-Source On-State Resistance		$V_{GS}$ =4.5V, $I_D$ =4A		34	48	mΩ
Forward Transconductance	<b>G</b> FS	V <sub>DS</sub> =5V,I <sub>D</sub> =6A		20	-	S
Dynamic Characteristics (Note4)			<b>'</b>			
Input Capacitance	C <sub>lss</sub>	V 05VV 0V		1920		PF
Output Capacitance	Coss	$V_{DS}=25V,V_{GS}=0V,$		155		PF
Reverse Transfer Capacitance	C <sub>rss</sub>	F=1.0MHz		116		PF
Switching Characteristics (Note 4)			•			
Turn-on Delay Time	t <sub>d(on)</sub>		-	8	-	nS
Turn-on Rise Time	t <sub>r</sub>	$V_{DS}$ =30V, $R_L$ =4.7 $\Omega$	-	5	-	nS
Turn-Off Delay Time	t <sub>d(off)</sub>	$V_{GS}$ =10 $V$ , $R_{GEN}$ =3 $\Omega$	-	29	-	nS
Turn-Off Fall Time	t <sub>f</sub>		-	6	-	nS
Total Gate Charge	Q <sub>g</sub>	V 00VI 04	-	50	-	nC
Gate-Source Charge	$Q_{gs}$	$V_{DS}=30V,I_{D}=6A,$	-	8	-	nC
Gate-Drain Charge	$Q_{gd}$	V <sub>GS</sub> =10V	-	16	-	nC
Drain-Source Diode Characteristic	cs					
Diode Forward Voltage (Note 3)	V <sub>SD</sub>	V <sub>GS</sub> =0V,I <sub>S</sub> =6A	-	-	1.2	V
Diode Forward Current (Note 2)	Is		-	-	7	Α
Reverse Recovery Time	t <sub>rr</sub>	TJ = 25°C, I <sub>F</sub> =7A	-	35	-	nS
Reverse Recovery Charge	Qrr	$di/dt = 100A/\mu s^{(Note3)}$	-	43	-	nC
Forward Turn-On Time	t <sub>on</sub>	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD)				

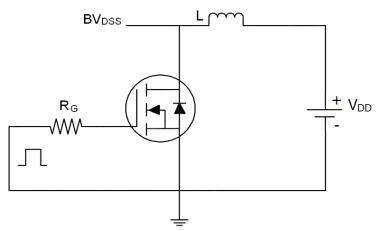
#### Notes:

- **1.** Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, t ≤ 10 sec.
- **3.** Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 2%.
- 4. Guaranteed by design, not subject to production

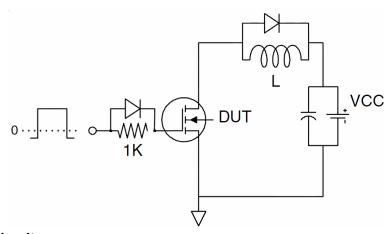


### **Test Circuit**

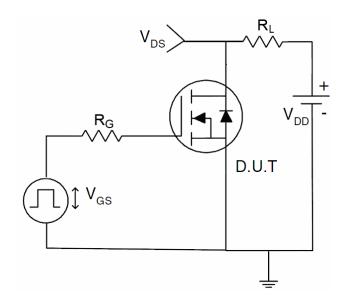
## 1) E<sub>AS</sub> test Circuits



## 2) Gate charge test Circuit

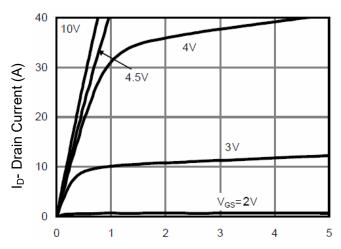


### 3) Switch Time Test Circuit



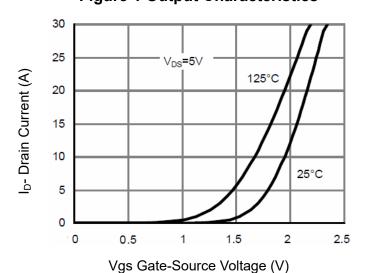


# Typical Electrical and Thermal Characteristics (Curves)



Vds Drain-Source Voltage (V)

Figure 1 Output Characteristics



**Figure 2 Transfer Characteristics** 

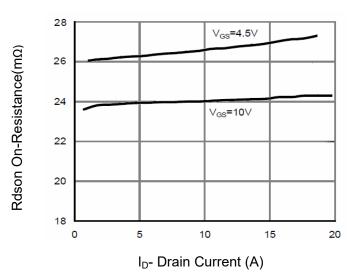


Figure 3 Rdson- Drain Current

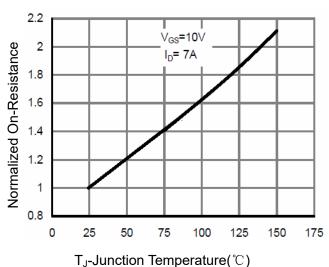


Figure 4 Rdson-JunctionTemperature

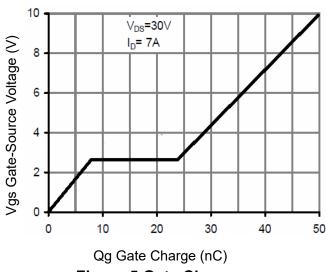


Figure 5 Gate Charge

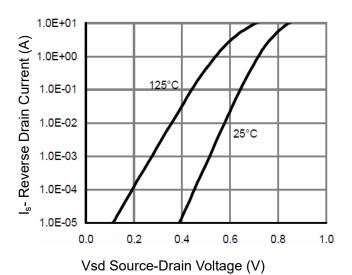


Figure 6 Source- Drain Diode Forward



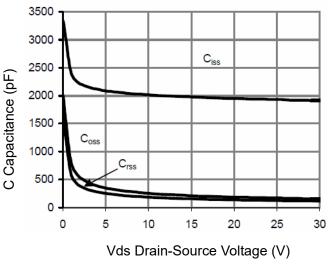


Figure 7 Capacitance vs Vds

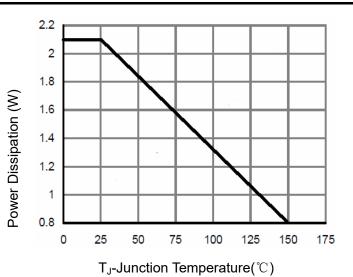


Figure 9 Power De-rating

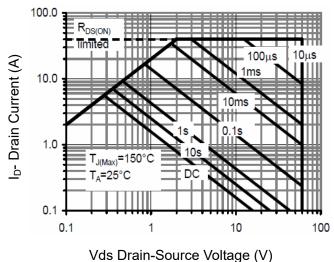


Figure 8 Safe Operation Area

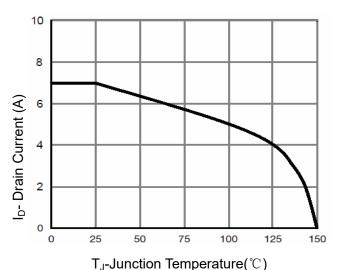


Figure 10 Current De-rating

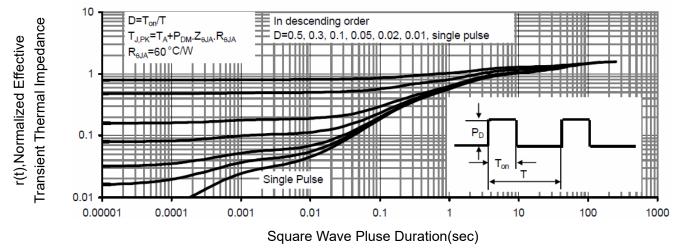
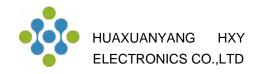
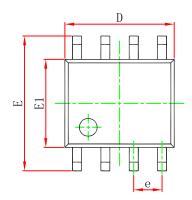
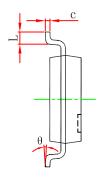


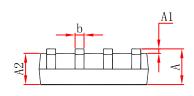
Figure 11 Normalized Maximum Transient Thermal Impedance



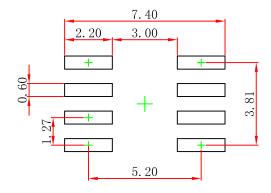
# **SOP-8 Package Outline Dimensions**







Symbol	Dimensions In Millimeters		Dimensions In Inches		
	Min	Max	Min	Max	
A	1.350	1.750	0.053	0.069	
A1	0.100	0. 250	0.004	0.010	
A2	1.350	1.550	0.053	0.061	
b	0.330	0.510	0. 013	0.020	
С	0.170	0. 250	0.007	0.010	
D	4.800	5. 000	0. 189	0. 197	
e	1.270 (BSC)		0.050 (BSC)		
Е	5.800	6. 200	0. 228	0. 244	
E1	3.800	4. 000	0. 150	0. 157	
L	0.400	1. 270	0.016	0.050	
θ	0°	8°	0°	8°	



- Note: 1.Controlling dimension:in millimeters.
- 2.General tolerance:± 0.05mm.
  3.The pad layout is for reference purposes only.

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